Reflective Object Sensor

QRD1113, QRD1114

Description

The QRD1113 and QRD1114 reflective sensors consist of an infrared emitting diode and an NPN silicon phototransistor mounted side by side in a black plastic housing. The on-axis radiation of the emitter and the on-axis response of the detector are both perpendicular to the face of the QRD1113 and QRD1114. The phototransistor responds to radiation emitted from the diode only when a reflective object or surface is in the field of view of the detector.

Features

- Phototransistor Output
- No-Contact Surface Sensing
- Unfocused for Sensing Diffused Surfaces
- Compact Package
- Daylight Filter on Sensor
- This Device is Pb-Free and RoHS Compliant



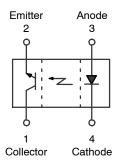
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REFLECTIVE RECTANGULAR SENSOR CASE 100BY

PIN ASSIGNMENT



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

QRD1114/D

QRD1113, QRD1114

ABSOLUTE MAXIMUM RATINGS

(Values are at T_A = 25°C unless otherwise specified)

Symbol	Parameter	Min.	Unit	
T _{OPR}	Operating Temperature	-40 to +85	°C	
T _{STG}	Storage Temperature	-40 to +100		
T _{SOL-I}	Lead Temperature (Solder Iron) (Notes 1, 2, 3)	240 for 5 s		
T _{SOL-F}	Lead Temperature (Solder Flow) (Notes 1, 2)	260 for 10 s		
MITTER				
IF	Continuous Forward Current	50	mA	
V_{R}	Reverse Voltage	5	V	
P_{D}	Power Dissipation	100	mW	
ENSOR				
V_{CEO}	Collector-Emitter Voltage	30	V	
V _{ECO}	Emitter-Collector Voltage	5	V	
Pn	Power Dissipation (Note 4)	100	mW	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. RMA flux is recommended.
- 2. Methanol or isopropyl alcohols are recommended as cleaning agents. 3. Soldering iron tip 1/16 inch (1.6 mm) minimum from housing.
- 4. Derate power dissipation linearly 1.33 mW/°C.

ELECTRICAL/OPTICAL CHARACTERISTICS (Values are at T_A = 25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
INPUT (EMITT	ER)	•				
V _F	Forward Voltage	I _F = 20 mA			1.7	V
I _R	Reverse Leakage Current	V _R = 5 V			100	μΑ
λ _{PE}	Peak Emission Wavelength	I _F = 20 mA		940		nm
OUTPUT (SEN	ISOR)					
BV _{CEO}	Collector-Emitter Breakdown	I _C = 1 mA	30			V
BV _{ECO}	Emitter-Collector Breakdown	I _E = 0.1 mA	5			V
I _D	Dark Current	V _{CE} = 10 V, I _F = 0 mA			100	nA
COUPLED						
I _{C(ON)}	QRD1113 Collector Current	$I_F = 20 \text{ mA}, V_{CE} = 5 \text{ V}, D = 0.050 \text{ inch}$	0.300			mA
I _{C(ON)}	QRD1114 Collector Current	(Notes 5, 7)	1			mA
V _{CE(SAT)}	Collector Emitter Saturation Voltage	I_F = 40 mA, I_C = 100 μ A, D = 0.050 inch (Notes 5, 7)			0.4	٧
I _{CX}	Cross Talk	I _F = 20 mA, V _{CE} = 5 V, E _E = 0 (Note 6)		0.2	10.0	μΑ
t _r	Rise Time	$V_{CE} = 5 \text{ V}, R_L = 100 \Omega, I_{C(ON)} = 5 \text{ mA}$		10		μs
t _f	Fall time			50		μs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 5. D is the distance from the sensor face to the reflective surface.
- 6. Crosstalk (I_{CX}) is the collector current measured with the indicated current on the input diode and with no reflective surface.
- 7. Measured using Eastman Kodak natural white test card with 90% diffused reflecting as a reflecting surface.

ORDERING INFORMATION

Ī	Part Number	Operating Temperature	Package	Top Mark	Packing Method
Ī	QRD1113	−40 to +85°C	Reflective Rectangular	QRD1113	Bulk
Ī	QRD1114	−40 to +85°C	Sensor PCB Mount	QRD1114	

QRD1113, QRD1114

TYPICAL PERFORMANCE CHARACTERISTICS

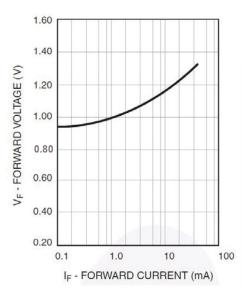


Figure 1. Forward Voltage vs. Forward Current

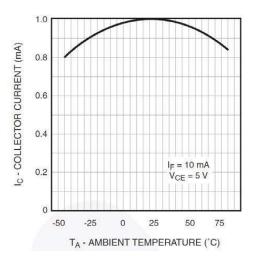


Figure 3. Normalized Collector Current vs. Temperature

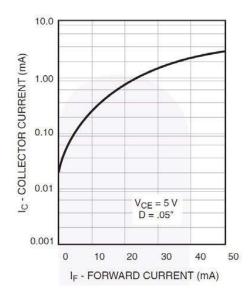


Figure 2. Normalized Collector Current vs. Forward Current

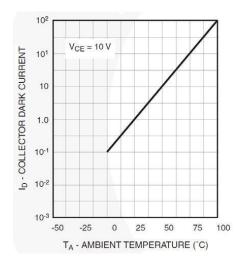


Figure 4. Normalized Collector Dark Current vs. Temperature

QRD1113, QRD1114

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

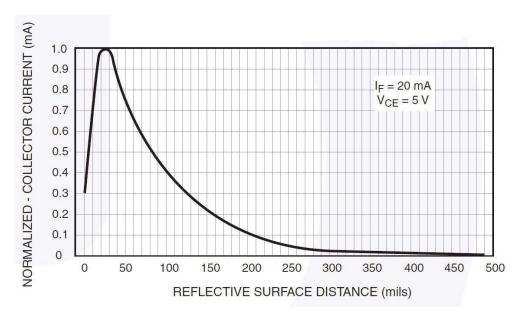
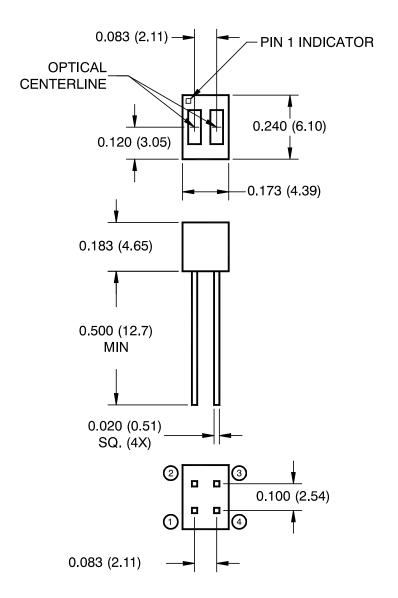


Figure 5. Normalized Collector Current vs. Distance

REFLECTIVE RECTANGULAR SENSOR PCB MOUNT

CASE 100BY ISSUE O

DATE 30 SEP 2016



Notes:

- 1.Dimensions for all drawings are in inches (millimeters).
- 2. Tolerance of ± .010 (.25) on all non-nominal dimensions unless otherwise specified.
- 3. Pins 2 and 4 typically .050" shorter than pins 1 and 3.
- 4. Dimensions controlled at housing surface.

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